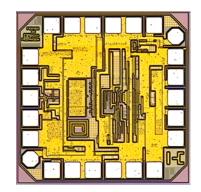




September 2004



## **Features**

- Integrated transimpedance and limiting amplifier for serial optical receiver applications
- Receiver sensitivity 20 μA<sub>pp</sub> for 10<sup>-12</sup> BER at 10 Gb/s
- Receive signal strength indicator (RSSI) for digital diagnostics and active alignment
- Loss of signal indicator (LOS)
- Optional squelch circuit disables output at low input levels
- Back-terminated 50-ohm CML output providing 250 mVpp differential amplitude
- No external passives required for photodiode bias network
- Single +3.3 V supply dissipating 115 mW

## **Applications**

- 850 nm and 1310 nm receive optical subassemblies (ROSA)
- XFP, X2, XPAC, XENPAC optical modules
- 10GbE, 10GFC, 8GFC, 4GFC, OC-192 VSR
- Proprietary back plane optics

## Description

The growing use of the Internet has created increasingly higher demand for multi-Gb/s I/O performance. The demand and availability of 10 Gb/s+ WAN bandwidth fuels the growth of native 10 Gb/s infrastructures within MAN and enterprise datacenters.

The Primarion® PX6420 10 Gb/s receiver is a single channel TIA/LA optical receiver designed for various 10 Gb/s PMD applications. It consists of a transimpedance amplifier and an AC-coupled differential limiting amplifier.

The transimpedance amplifier achieves a nominal bandwidth of 8 GHz over a wide range of photodiode input capacitance. A photodiode bias current monitor allows for a simple alignment procedure.

The transimpedance amplifier is AC-coupled internally to a high-gain, high-bandwidth, limiting amplifier. The limiting amplifier provides a differential back-terminated CML output that can be used to drive 10 Gb/s Serdes or other CML compatible circuits.

Full diagnostics are delivered through loss of signal, squelch, and received signal strength indicator circuits.

Figure 1: 10 Gb/s differential data output using a PRBS23 optical data input pattern

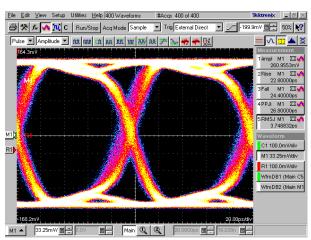


Figure 2: Diagram shows a typical bonding configuration for the PX6420 mounted on a TO-46 header. The figure shows a photodiode attached directly on the PX6420 IC. Also shown are two microwave chip capacitors used for VCC decoupling. Capacitor values of 200 fF are typical but vary by application environment.

3.3 V

GND

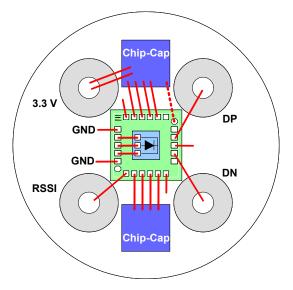
GND

Chip-Cap

DN

Chip-Cap

**Figure 3:** Similar configuration as Figure 2. Sq\_En connected to VCC disables the limiting amplifier when LOS is asserted.





## For more information about all Zarlink products visit our Web Site at www.zarlink.com

Information relating to products and services furnished herein by Zarlink Semiconductor Inc. or its subsidiaries (collectively "Zarlink") is believed to be reliable. However, Zarlink assumes no liability for errors that may appear in this publication, or for liability otherwise arising from the application or use of any such information, product or service or for any infringement of patents or other intellectual property rights owned by third parties which may result from such application or use. Neither the supply of such information or purchase of product or service conveys any license, either express or implied, under patents or other intellectual property rights owned by Zarlink or licensed from third parties by Zarlink, whatsoever. Purchasers of products are also hereby notified that the use of product in certain ways or in combination with Zarlink, or non-Zarlink furnished goods or services may infringe patents or other intellectual property rights owned by Zarlink.

This publication is issued to provide information only and (unless agreed by Zarlink in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. The products, their specifications, services and other information appearing in this publication are subject to change by Zarlink without notice. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. Manufacturing does not necessarily include testing of all functions or parameters. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to Zarlink's conditions of sale which are available on request.

Purchase of Zarlink's I<sup>2</sup>C components conveys a licence under the Philips I<sup>2</sup>C Patent rights to use these components in and I<sup>2</sup>C System, provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.

Zarlink, ZL and the Zarlink Semiconductor logo are trademarks of Zarlink Semiconductor Inc.

Copyright Zarlink Semiconductor Inc. All Rights Reserved.

TECHNICAL DOCUMENTATION - NOT FOR RESALE